

### PRODUCT CHANGE NOTICE

### PCN-2488 REV 1

Notification Date:	Implementation Date:	Product Family:	Change Type:	PCN #:
October 20, 2020	January 20, 2021	Analog	Fab Change, A/T Site and BOM	2488

#### TITLE

Fab Porting from Global Foundries to MagnaChip, Assembly Site Transfer, and BOM Change

#### **DESCRIPTION OF CHANGE**

As already announced in PCN-2326 Global Foundries in Woodlands, Singapore closed their 0.35um technology wafer production on December 15, 2018.

In order to assure continuity of supply, Diodes transferred wafer manufacturing to Magnachip Semiconductor located in Heungdeok-gu, Korea using 0.30um technology.

This PCN is being issued to notify customers that, in order to assure continuity of supply, Diodes will transfer assembly and test to Greatek Electronics Inc. in Miaoli, Taiwan. Diodes is also changing the device marking including Diodes logo (see Figure 1).

Full electrical characterization and high reliability testing has been completed on representative part numbers. Refer to the attached qualification / reliability report (embedded in this file).

# **IMPACT**

Continuity of Supply. No impact to fit and function.

#### **PRODUCTS AFFECTED**

Table 1 - Fab Porting (Global Foundry to Magnachip)

Table 2 - Fab Porting (Global Foundry to Magnachip), New A/T Site(UTAC to Greatek) and New BOM(Copper bond wire)

Table 3 - Fab Porting (Global Foundry to Magnachip) and New BOM (Copper bond wire)

WEB LINKS			
Manufacturer's Notice: <a contacts.html"="" href="https://www.diodes.com/quality/product-change-notices/diodes-pro&lt;/th&gt;&lt;/tr&gt;&lt;tr&gt;&lt;th colspan=2&gt;For More Information Contact: &lt;a href=" http:="" www.diodes.com="">http://www.diodes.com/contacts.html</a>			
Data Sheet: <a href="http://www.diodes.com/catalog">http://www.diodes.com/catalog</a>			

# **DISCLAIMER**

Unless a Diodes Incorporated Sales representative is contacted in writing within 30 days of the posting of this notice, all changes described in this announcement are considered approved.

Rel Date: 2/8/2019



Table 1 - Fab Porting (Global Foundry to Magnachip)				
PI49FCT20807HE	PI49FCT20807HEX			

Table 2 - Fab Porting (Global Foundry to Magnachip), New A/T Site(UTAC to Greatek) and New BOM (Copper bond wire)				
PI49FCT20802LEX	PI49FCT32803LEX	PI49FCT3803LEX		

Table 3 - Fab Porting (Global Foundry to Magnachip) and New BOM (Copper bond wire)					
PI49FCT20807QE	PI49FCT32807QE	PI49FCT3805CQE	PI49FCT3807QE		
PI49FCT20807QEX	PI49FCT32807QEX	PI49FCT3805CQEX	PI49FCT3807QEX		
PI49FCT32802LE	PI49FCT3805AQE	PI49FCT3805QE	PI6CV2304WE		
PI49FCT32802LEX	PI49FCT3805AQEX	PI49FCT3805QEX	PI6CV2304WEX		
PI49FCT32805QE	PI49FCT3805BQE	PI49FCT3807CQE	PI6CV304WE		
PI49FCT32805QEX	PI49FCT3805BQEX	PI49FCT3807CQEX	PI6CV304WEX		

Figure 1- Marking Change

# Old marking

# New marking



B: Fab 2 port code

W: Die Rev YY: Year

WW: Workweek X: Assembly Code X: Fab Code

Bar above fab code denotes Cu wire



YY: Year

WW: Workweek

1st X: Assembly Code 2nd X: Fab Code

Bar above fab code denotes Cu wire

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